### DATA SHEET



## MOS FIELD EFFECT TRANSISTOR

# 2SK2141

#### SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The 2SK2141 is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

#### **FEATURES**

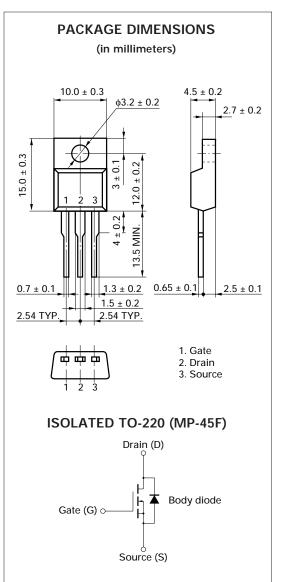
- Low On-state Resistance
- $R_{DS(on)} = 1.1 \ \Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 3.0 \ A)$
- Low Ciss Ciss = 1150 pF TYP.
- High Avalanche Capability Ratings
- Isolated TO-220 (MP-45F) Package

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C)

Drain to Source Voltage	Vdss	600	V		
Gate to Source Voltage	Vgss	±30	V		
Drain Current (DC)	D (DC)	±6.0	А		
Drain Current (pulse)	D (pulse)*	±24	А		
Total Power Dissipation (Tc = 25 °C)	Pt1	35	W		
Total Power Dissipation (Ta = 25 $^{\circ}$ C)	Рт2	2.0	W		
Storage Temperature	Tstg -55	5 to +150	°C		
Channel Temperature	Tch	150	°C		
Single Avalanche Current	As**	6.0	А		
Single Avalanche Energy	Eas**	12	mJ		
*PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%					
**Starting T <sub>ch</sub> = 25 °C, R <sub>G</sub> = 25 $\Omega$ , V <sub>GS</sub> = 20 V $\rightarrow$ 0					

The diode connected between the gate and source of the

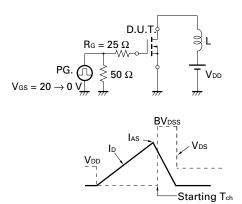
transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



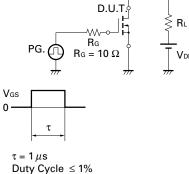
#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		0.8	1.1	Ω	Vgs = 10 V, Id = 3.0 A
Gate to Source Cutoff Voltage	VGS(off)	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	yfs	2.0			S	Vds = 10 V, Id = 3.0 A
Drain Leakage Current	IDSS			100	μA	$V_{DS} = 600V, V_{GS} = 0$
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V},  V_{DS} = 0$
Input Capacitance	Ciss		1150		pF	$V_{DS} = 10 V$
Output Capacitance	Coss		260		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		60		pF	f = 1 MHz
Turn-On Delay Time	td(on)		15		ns	Vgs = 10 V
Rise Time	tr		15		ns	V <sub>DD</sub> = 150 V
Turn-Off Delay Time	td(off)		75		ns	ID = 3.0 A, Rg = 10 Ω
Fall Time	tr		13		ns	RL = 37.5 Ω
Total Gate Charge	Q <sub>G</sub>		40		nC	Vgs = 10 V
Gate to Source Charge	Q <sub>GS</sub>		6.0		nC	ID = 6.0 A
Gate to Drain Charge	Qgd		20		nC	V <sub>DD</sub> = 480 V
Diode Forward Voltage	VF(S-D)		1.0		V	$I_F = 6.0 \text{ A}, \text{ V}_{GS} = 0$
Reverse Recovery Time	trr		370		ns	IF = 6.0 A
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/µs

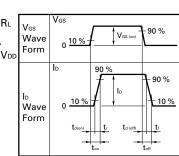
#### **Test Circuit 1: Avalanche Capability**



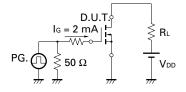
**Test Circuit 2: Switching Time** 



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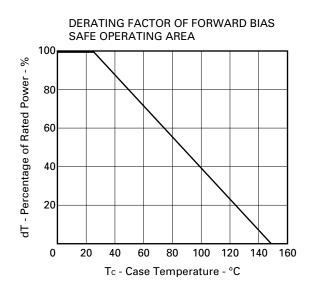


#### **Test Circuit 3: Gate Charge**

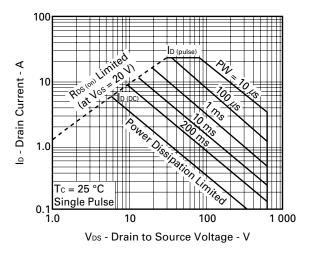


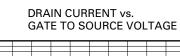
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

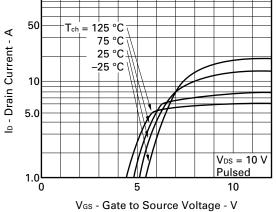


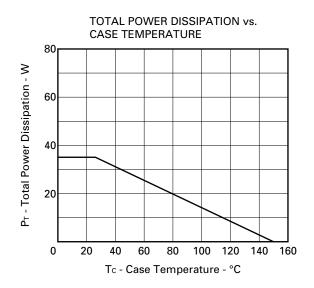


FORWARD BIAS SAFE OPERATING AREA

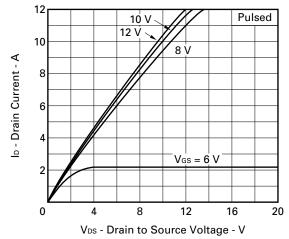




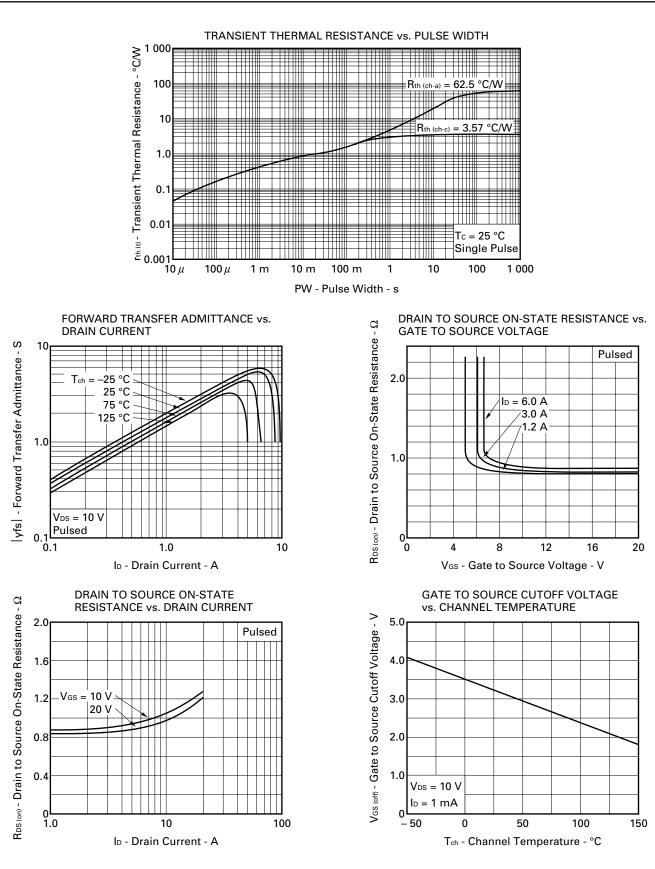


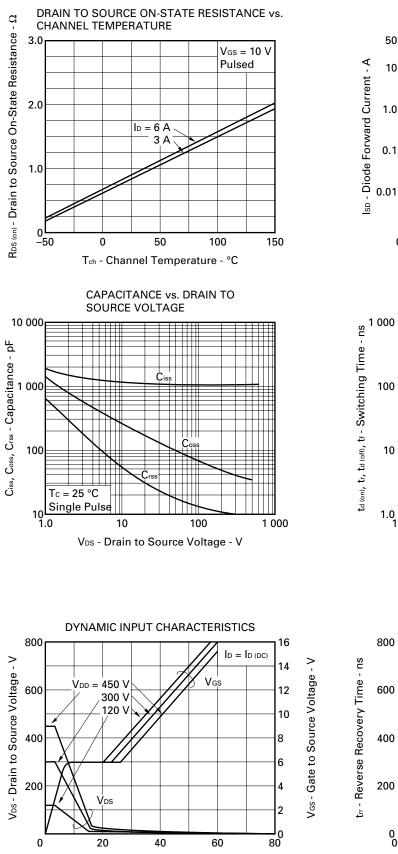


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

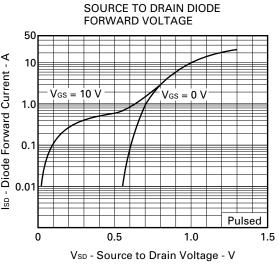


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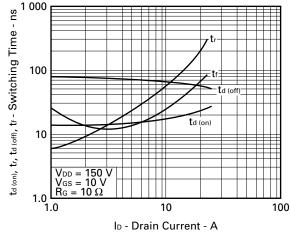


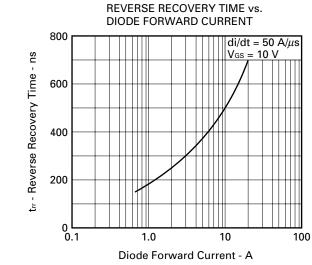


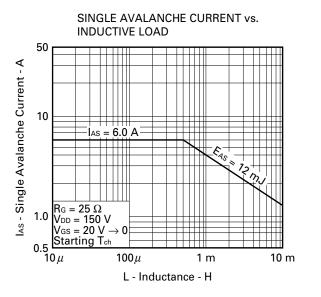
Qg - Gate Charge - nC



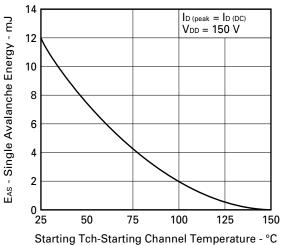
SWITCHING CHARACTERISTICS







SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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